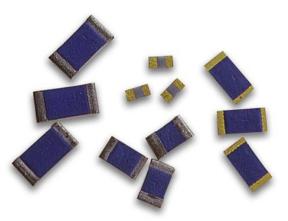
# **High Reliability Thick Film Chip Resistors**



# **CR Series**

#### Features:

- Available to EN140401 & IECQ-CECC40401 release
- 100% high temperature and overload screened versions available
- Terminations available for wire bonding or soldering
- Resistance range 1R0 to 100M
- Tolerances down to 0.1%
- Zero-ohm links available





All Pb-free parts comply with EU Directive 2011/65/EU amended by (EU) 2015/863 (RoHS3)

# **Electrical Data**

Commercial		CR0503	CR0603	CR0805	CR1005	CR1206	CR2010	CR2512	
Power rating at 70°C	W	0.063	0.1	0.1	.25	0.25	0.5	1	
Resistance range	Ω	1R0 -	- 10M	1R0 – 100M 1R0 – 1N				- 1M0	
Limiting element voltage	V	50	75	15	50	200	400	500	
TCR -55 to +155°C	ppm/°C	<10R: 200, 10R-1M0: 100, >1M0:250							
Resistance tolerance <sup>1</sup>	%	0.1, 0.25, 0.5, 1, 2, 5							
Ambient temperature range	°C	-55 to +155							
Values <sup>2</sup>		E24 & E96 preferred							
Thermal impedance	°C/W	800	550	360	290	200	80	70	
Zero-ohm rating	Α	- 1 1.5 - 2 3							
Zero-ohm residual resistance	mΩ	•			<20	•	•	•	

Note 1: See table of value ranges. Note 2: Non-standard values may be requested. Note 3: Anti-sulphur versions available – consult factory.

The requirements of the following standards are met or exceeded by the corresponding CR products above

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EN140401-802 Requirements		RR2012M		RR3216M						
Power rating at 70°C W		0.125		0.25						
Resistance range $\Omega$		1R5 – 10M		1R5 – 10M						
Limiting element voltage V										
TCR -55 to +125°C ppm/°C	<10R: 200, 10R-1M0: 100, >1M0:200									
Resistance tolerance %		<10R: 5, 10	R-1M0: 1, 2,	5, >1M0: 5						
Ambient temperature range °C			-55 to +125							
IECQ-CECC 40401-004 Requirements		CR0805		CR1206						
Power rating at 70°C W		0.125		0.25						
Resistance range $\Omega$	1R0 – 10M 1R0 – 10M									
Limiting element voltage V	100 200									
TCR -55 to +125°C ppm/°C	<10R: 200, 10R-1M0: 100, >1M0:200									
Resistance tolerance %	1, 2, 5									
Ambient temperature range °C	-55 to +125									
IECQ-CECC 40401-008 Requirements	CR0603 <sup>1</sup>	CR0805		CR1206	CR2010	CR2512				
Power rating at 70°C W	0.1	0.125		0.25	0.5	1				
Resistance range $\Omega$	1R0 -	- 10M		1R0 – 10M	1R0 -	· 1M0				
Limiting element voltage V	75	75 100 200 400								
TCR -55 to +155°C ppm/°C		<10R: 200, 1	10R-1M0: 100	,>1M0:250						
Resistance tolerance %	0.5, 1, 2, 5	0.1	, 0.25, 0.5, 1, 2	2, 5	0.25, 0.5	5, 1, 2, 5				
Ambient temperature range °C			-55 to +155							

Note 1: CR0603 meets the requirements of IECQ-CECC 40401-008. Certification pending.

IECQ-CECC 40401-003 Requi	irements		CR0805		CR1206		
Power rating at 70°C	ver rating at 70°C W		0.063		0.125		
Resistance range	Ω		1R0 – 3M0		1R0 – 5M0		
Limiting element voltage	V		100		200		
TCR -55 to +125°C	ppm/°C	<5R0: 500, 5R0-10R: 350, 10R-3M0: 100, >3M0:250					
Resistance tolerance	%	0.5, 1, 2, 5					
Ambient temperature range	°C			-55 to +125			

# **High Reliability Thick Film Chip Resistors**



# **CR Series**

# **Physical Data**

Dimen	sions in m	m and weigl	nt in n	ng			
	L	w	T max.	Α	B¹ min.	С	Wt.
0503G	1.25±0.1	0.63±.1	0.5	-	-	0.2±0.1	1.5
0603F				0.3±0.15	0.6	-	
0603G	1.6±0.1	0.8±0.1	0.55	-	-	0.3±0.15	2.2
0805F	2 2 2 4 5	1 25 : 2 45		0.3±0.15	0.9	-	
0805G	2.0±0.15	1.25±0.15	0.6	-	-	0.3±0.1	4.7
1005G	2.5±0.2	1.25±0.2		-	-	0.4±0.15	6.5
1206F	3.2±0.2	1.6±0.2	0.7	0.4±0.2	1.7	-	8.5
1206G	3.2±0.2	1.0±0.2		-	-	0.4±0.15	8.5
2010F	5.1±0.3	2.5±0.2		0.6±0.3	3	-	36
2010G	5.1±0.5	2.5±0.2	0.8	-	-	0.6±0.25	
2512F	6.5±0.3	3.2±0.2	0.8	0.6±0.3	4.4	-	55
2512G	0.5±0.5	3.210.2		-	-	0.6±0.25	

Note 1: This dimension determines the number of conductors which may pass under the surface mounted device.

#### Construction

Thick film resistor material, overglaze and organic protection are screen printed on a 96% alumina substrate.

#### **Terminations**

Planar (or single-sided) termination is gold and suitable for wire-bonding. Wrap-around termination is suitable for soldering.

#### Solderability

Wrap-around terminations have an electroplated nickel barrier and a 100% Sn or SnPb coating. This ensures excellent leach resistance properties and solderability. They will withstand immersion in solder at 260°C for 30 seconds.

#### Marking

All relevant information is recorded on the primary package or reel.

### **Performance Data**

		EN140401-802	IECQ-CECC	IECQ-CECC	IECQ-CECC	Actual Per	formance
		Requirements 40401-008		40401-004 Requirements	40401-003 Requirements	Maximum <sup>2</sup>	Typical
Load at rated power: P <sub>r</sub> for 1000 hours at 70°C	±ΔR%	1 <sup>3</sup>	1 <sup>3</sup> 2 <sup>2</sup> 2 <sup>4</sup>		≤3M3: 2 <sup>4</sup> >3M3: 3 <sup>4</sup>	1	0.25
Dry heat: No load, 1000 hours at 155°C	±ΔR%	1³	2 <sup>2</sup>	1 <sup>3</sup> ≤3M3: 2 <sup>4</sup> >3M3: 3 <sup>4</sup>		≤10M: 1 >10M: 2	≤10M: 0.2 >10M: 1
Shelf life test: 12 months at room temperature	±ΔR%		0.1 0.02				
Derating from rated power at 70	)°C	Zero @125°C	Zero @155°C	Zero @125°C	Zero @125°C	Zero @155°C	
Short term overload: Lesser of 6.25xP <sub>r</sub> or 2.5xLEV for 2s ±ΔR		0.25 <sup>3</sup>	0603,0805: 1 <sup>3</sup> 1206: 0.5 <sup>3</sup>	0.5 <sup>3</sup>	2 <sup>4</sup>	1 ¹	0.1
Long term damp heat ±ΔR9		1 <sup>3</sup>	2 <sup>2</sup>	2 4	2 4	1	0.25
Temperature rapid change	±∆R%	0.25 <sup>3</sup>	0.5 <sup>3</sup>	0.5 <sup>3</sup>	1 4	0.25	0.05
Resistance to solder heat	±∆R%	0.25 <sup>3</sup>	0.5 <sup>3</sup>	0.5 <sup>3</sup>	2 4	0.25	0.05
Voltage proof	V	0805: 284 1206: 426	0603, 0805: 213 1206: 284 2010: 568 2512: 710	0805: 284 1206: 426	0805: 142 1206: 284		0603: 300 206: 500 2512: 710

Note 1: All values within the qualified resistance range meet EN140401 and IECQ-CECC40401 requirements.

Note 2: Apply an ohmic addition of R01.

Note 3: Apply an ohmic addition of R05.

Note 4: Apply an ohmic addition of R10.

# **High Reliability Thick Film Chip Resistors**





# Value Ranges

	Tolerance %										
Size	5	2	1	0.5	0.25	0.1					
0503	100	– 10M	10R – 10M	100R – 1M0							
0603	IKU	- 10IVI	1R0 – 10M	100K – 11VIO	·						
0805			1R0 – 20M		100R – 1M0						
1005	1R0 – 100M	1R0 – 50M	1KU – 2UIVI								
1206			1R0 – 25M	10R – 10M							
2010		1R0 – 1M0				_					
2512		1KO – 1MO				_					

### **Application Notes**

### **Operating Temperature Range**

The chips themselves can operate at a maximum temperature of 155°C (see performance claims above). For soldered chips, the joint temperature should not exceed 110°C. This condition is met when the stated power levels at 70°C are used.

#### Mounting

This chip resistor is ideally suited for handling by automatic methods due to its rectangular shape and the small dimensional tolerances. Electrical connection to a ceramic substrate or to a printed circuit board can be made by wire bonding (e.g. suffix 'G' in CR0805G) or by reflow soldering of wrap-around terminations (e.g. suffix 'F' in CR0805F). The 'F' terminations provide good leach properties and ensure reliable contact. Due to the robust construction the resistor chip can be immersed in the solder bath for 30 seconds at 260°C. This enables the resistor to be mounted on one side of a printed circuit board and other wire-leaded components on the other side.

#### **Packaging**

Solderable wraparound chips are supplied in plastic tape and reeled to IEC 286-3. The 2512 size is packed at 4mm pitch on 12mm wide tape, and the smaller sizes are on 8mm wide tape. Other dimensions conform to:

https://www.ttelectronics.com/TTElectronics/media/ProductFiles/ApplicationNotes/PS003-Packing-of-Specialist-Chip-Resistors.pdf

Gold pad planar chips are supplied in waffle packs.

# **Ordering Procedure**

Example: CR2512F-10KFI (2512 with solderable wraparound terminations, 10 kilohms ±1%, Pb-free )



1	2	3 4			4	5		(	6	7	
Туре	Size		Term	nination	Value	Tolerance		Termination Fi	Release		
CR	0503		0603,			B = ±0.1%	% Pb-free solderable (RoHS)			Omit for	
	0603		0805,			E24 or E96	C = ±0.25%		0603F	Std 2000 (max 5000)/reel	commercial or
	0805	F	1206,					3/4 characters	D = ±0.5%	ı	0805F, 1206F, 2010F
	1005		2010,	wraparound	R = ohms K = kilohms	F = ±1%		2512F	Std 800 (max 1800)/reel	EN =	
	1206		2512		M = megohms	G = ±2%		SnPb so	EN140401-802		
	2010	G	All	Gold planar	J	J = ±5%		0603F	Std 2000 (max 5000)/reel		
	2512				R005J = zero-c	ohm jumper	РΒ	0805F, 1206F, 2010F	Std 800 (max 3000)/reel		
,								2512F	Std 800 (max 1800)/reel		
								Gold			
							ı	xxxxG	Waffle pack		

Note 1: For CECC released product follow the MPN with text indicating the relevant release. (Note that this additional text does not form part of our MPN.) Example: CR2512F-10KFI IECQ-CECC40401-008